



DOCKET NO.: 4599/CIP

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN THE MATTER OF THE APPLICATION FOR PATENT

OF: Gerhard SCHMITZ et al.

| Art Unit: 1772

SERIAL NO.: 10/724,311

| Confirmation No. 1434

FILED: November 28, 2003

FOR: Insulating Arrangement for the
Inner Insulation of an Aircraft

MS MISSING PARTS
COMMISSIONER FOR PATENTS
P.O. BOX 1450
ALEXANDRIA, VA 22313-1450

May 3, 2004

INFORMATION DISCLOSURE STATEMENT AND CERTIFICATE OF MAILING

Dear Sir:

- 1) Pursuant to 37 C.F.R. §§ 1.56, 1.97 and 1.98 applicants enclose a Form PTO-1449 and copies of the cited references AE, AJ, AK, AM and AN. Copies of the other references are available in the parent application 09/830,625 of this CIP, and thus do not need to be resubmitted herein.
- 2) This statement is being filed together with the reply to the Notice to File Missing Parts in the above identified application, thus before issuance of the first Office Action on the merits, so no fee is due.
- 3) References AA to AH and AL to AN are in English. Reference AI has the same relevance herein as in the parent application. Reference AJ includes an English Abstract and is the PCT Publication of the international counterpart of the parent

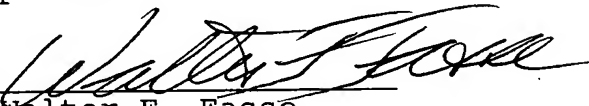
application of this CIP. Reference AK includes English claims and is the European counterpart of the parent application of this CIP. No further discussion of the references is necessary.

- 4) Applicants respectfully request that the Examiner consider all references of record, return an initialled copy of the enclosed Form PTO-1449 and ensure that all references of record are printed on any patent issuing from this application.
- 5) Favorable consideration and allowance of claims 1 to 39 are respectfully requested.

Respectfully submitted,

Gerhard SCHMITZ et al.
Applicant

WFF:ar/4599/CIP
Enclosure: postcard,
1 Form PTO-1449,
5 references

By 
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CERTIFICATE OF MAILING:

I hereby certify that this correspondence with all indicated enclosures is being deposited with the U. S. Postal Service with sufficient postage as first-class mail, in an envelope addressed to: COMMISSIONER FOR PATENTS, P.O. BOX 1450, ALEXANDRIA, VA 22313-1450 on the date indicated below.

 5/3/04
Name: Walter F. Fasse - Date: May 3, 2004

Sheet 1 of 1

Atty. Docket No.
4599/CIPSerial No.:
10/724,311LIST OF REFERENCES CITED BY
APPLICANT

(REVISED FORM PTO-1449)

DATED May 3, 2004

Applicant: Gerhard SCHMITZ et al.

U.S. Filing Date:
November 28, 2003Art Unit:
1772

MAY 06 2004

U. S. PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NO.	DATE	NAME	Cl.	Sub- Cl.	File Date
AA	5 1 2 6 3 8 0	06/1992	Stahlke et al.	-	-	-
AB	5 2 4 0 5 2 7	08/1993	Lostak et al.	-	-	-
AC	5 3 9 8 8 0 9	03/1995	White et al.	-	-	-
AD	5 4 7 2 7 6 0	12/1995	Norvell	-	-	-
AE	5 5 6 5 2 5 4	10/1996	Norvell	-	-	-
AF	5 0 1 1 1 6 7	09/1998	Norvel	-	-	-
AG	6 0 2 7 5 4 6	02/2000	Kusters et al.	-	-	-
AH	6 3 2 5 2 7 2	12/2001	May et al.	-	-	-

FOREIGN PATENT DOCUMENTS

	DOCUMENT NO.	DATE	COUNTRY	Cl.	Sub- Cl.	Trans.	
						Yes	No
AI	1 0 2 2 7 3 1	03/1953	France	-	-		x
AJ	W000 / 2 4 6 3 2	05/2000	PCT	-	-	=AK (Abst.)	
AK	1 1 2 4 7 2 0	08/2001	Europe	-	-	=AJ+ Eng. Claims	x

OTHER DOCUMENTS

AL	United States Patent Application Publication No. US 2002/0124431 A1, Published on September 12, 2002; Duhaut et al.; cover page and pages 1 to 8.
AM	Uhlhorn et al.; "Gas transport and separation with ceramic membranes, Part I. Multilayer diffusion and capillary condensation"; Elsevier Science Publishers B.V., Amsterdam, Journal of Membrane Science, 66 (1992), pages 259-269.
AN	Worner et al.; "Theoretical and Experimental Investigation of the Humidity Transport in Aircraft Cabins"; 8 th AIAA/ASME Joint Thermophysics and Heat Transfer Conference, June 24 - 27, 2002, St. Louis, Missouri.

EXAMINER

DATE CONSIDERED

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.